

ZM3

MISSION COMPUTER

Space Saving, Ultra-Lightweight
Rugged Computer for Airborne
ISR Applications



zmicro.com

Smaller, Lighter & Faster Computing

The ZM3 mission computer is designed specifically to minimize size, weight and power for airborne ISR applications. Built to provide advanced compute processing in the smallest form-factor possible, the ZM3 offers full server capability in a small, rugged packaging. The system supports double-wide COTS high-end graphics cards and an additional PCI Express card for custom user expansion. Utilizing an advanced Type 7 COM Express module, the ZM3 can utilize up to 16 Core Intel® Xeon® Processor with up to 48G RAM.

Designed For Airborne Environments

The ZM3 is carefully engineered to handle the extreme conditions of airborne environments. Designed and tested to DO-160G requirements for vibration, shock, temperature, humidity, dust and EMI/EMC, the ZM3 provides powerful compute capabilities with robust environmental design to ensure your missions will be a success.

NVMe Based Removable Storage Drives

Further reducing weight, the ZM3 can house up to two TranzPak 1 rugged storage drives up to 4TB (2TB each), which utilize the latest NVMe technology to provide storage read/write speeds up to 3x faster than SATA and only weigh 3 oz. each.



TranzPak 1 Storage Module



The ZM3 is unique because it's the smallest, lightest rugged mission computer available that can support an NVIDIA GPU card.

HIGHLIGHTS

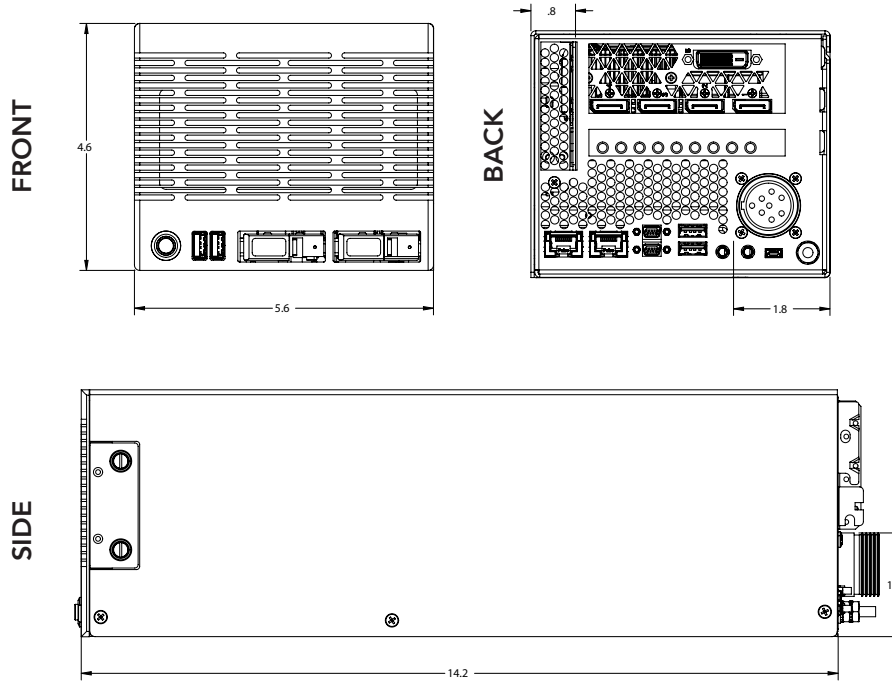
- Lightweight aluminum construction, weighing less than 10 lbs.
- Compact size: 4.6"H x 5.6"W x 14.2"D
- Up to 4TB NVMe based removable storage
- 2x front access USB 3.0 Ports
- MIL-DTL-38999 Locking Power Connector
- Up to 16 CORE, 1.3GHZ+ Intel® Xeon® processor
- DDR4 RAM, up to 48GB
- Flexible PCI expansion options: Up to 3 PCIe cards
- Onboard dual 10GigE and Audio
- Configurable Dual Serial Ports supporting RS422 or RS232
- 450W, 18-36V DC power input with EMI filter
- Illuminated power button for system status
- Field-replaceable dust filter

FOR MORE INFO

Contact us at sales@zmicro.com
or call 858.831.7000.



MECHANICAL OUTLINE



TECHNICAL SPECIFICATIONS

SIZE & WEIGHT	Dimensions	4.6"H x 5.6"W x 14.2"D	
	Weight	9.2 - 9.7 lbs. (depending on configuration)	
	TP1 Weight	3.2 oz. each	
POWER	Power Supply	DC Power Supply, 450W Max	
	Input Range	18-36 VDC @ 46 to 26A (Inrush current 100 Amps @ 24VDC @ 25°C)	
OPTIONS	COM Express Module	Type 7 COM Express	
	Memory	DDR4 RAM, up to 48GB	
	Storage	Up to 4TB of removable TranzPak 1 (TP1) based storage (2TB per TP1)	
	Graphics	Latest NVIDIA™ & ATI® graphics video cards	
	PCI Add-On Slots	Up to 3 PCIe cards	
ENVIRONMENTAL	Operating Temperature	DO-160G Section 4 Cat: A1: -15° to 55°C	
	Non-Operating Temperature	DO-160G Section 4 Cat: A1: -55° to 85°C	
	Operating Altitude	DO-160G Section 4 Cat: A1: Up to 15,000 ft.	
	Non-Operating Altitude	MIL-STD-810G, Method 500.5: Up to 40,000 ft.	
	Decompression	DO-160G Section 4 Cat: A1: Up to +8,000 ft.	
	Overpressure	DO-160G Section 4 Cat: A1: Up to -15,000 ft.	
	Temperature Variation	DO-160G Section 5 Cat: C: -15° to 55°C	
	Humidity	DO-160G Section 6 Cat: A	
	Shock	DO-160G Section 7 Cat: B Aircraft Type: All Fixed-Wing Type 4	
	Vibration	DO-160G Section 8 Cat: S Curve M	
	EMI/EMC	DO-160G, Section 16 & 17, Category B; DO-160G, Section 18, Category Z; DO-160G, Section 19, Category AC; DO-160G, Section 20, Category S; DO-160G, Section 21, Category L	
	OTHER	Quality	IPC/ISO 9001:2015 and applicable sections of the MIL-HDBK-454

ZMicro, Inc. is an ISO 9001:2015 certified company and compliant with AS 9100 requirements. Product information and technical data provided are typical of standard configurations of the described products. Measured results may vary slightly between units. This information is subject to change without notice. For more information, or the latest version of this product sheet, please visit our website @ www.zmicro.com